

SIMATIC IPC847D (Rack PC) (Rack PC, 19", 4HU); 2x Gbit Ethernet (IE/PN), RJ45; 1x DVI-I; 2x display ports; 1x COM 1; 2x PS/2; audio; 4x USB 3.0 incl. 1x internal; 3x USB 2.0; Temp. and fan monitoring; Watchdog, Card retainer XEON E3-1268LV3 (4C/8T, 2.3 (3.3) GHz, 8 MB cache VT-D, AMT); Basic board with PROFIBUS/MPI (CP 5622-compatible) RAID1, 1 TB (2x 1 TB HDD SATA, mirror disks), internal 0.5 g vibration, 5 G shock 32 GB DDR3 SD-RAM (4x 8 GB), Dual channel Bus module 11 slots: 7X PCI, 3x PCIE X4, 1x PCIE X16; DVD +/-RW (SLIM) COM2; LPT (1 slots occupied); graphics onboard; Adapter cable DVI-I according to VGA for onboard graphics Windows Server 2008 R2 Standard Edition incl. 5 clients, 64 bit, MUI (de, en, fr, es, it), SP1 without software 2x 110/240V redund. power supply; without line cable

Installation type/mounting	
Design	Rack PC, 19", 4U
Supply voltage	
Type of supply voltage	100/240 V AC (autorange) 50 / 60 Hz; optional redundant 100/240 V AC; optional 100/240 V AC with UPS functionality incl. maintenance-free lead-tin battery
Line frequency	
<ul style="list-style-type: none"> <li>Rated value 50 Hz</li> <li>Rated value 60 Hz</li> </ul>	<p>Yes</p> <p>Yes</p>
Mains buffering	
<ul style="list-style-type: none"> <li>Mains/voltage failure stored energy time</li> </ul>	20 ms
Processor	
Processor type	Xeon E3-1275 v3 (4C/8T, 3.5 (3.9) GHz, 8 MB cache); Xeon E3-1268L v3 (4C/8T, 2.3 (3.3) GHz, 8 MB cache); Core i5-4570TE (2C/4T, 2.7 (3.3) GHz, 4 MB cache); Core i3-4330TE (2C/4T, 2.4 GHz, 4 MB cache)
Chipset	Intel DH82C226 PCH
Drives	
Optical drives	DVD±R/RW (SlimLine)
Hard disk	500 GB HDD, 1 TB HDD, 2x 1 TB HDD, RAID1 (2x 1 TB HDD, mirror disks), RAID1 (2x 1 TB HDD, mirror disks) + 1x 1 TB HDD as hot spare, RAID5 (3x 1 TB HDD, striping with parity), RAID5 (3x 1 TB HDD, striping with parity) + 1x 1 TB HDD as hot spare; RAID1 (2x 1 TB HDD SAS, mirror disks), RAID5 (3x 1 TB HDD SAS, striping with parity), RAID5 (3x 1 TB HDD SAS, striping with parity) + 1x 1 TB HDD SAS as hot spare incl. PCIe (x8) RAID SAS controller incl. ZMCP module

SSD	Yes; 240 GB SSD; RAID1 (2x 240 GB SSD, mirror disks)
Slot for drives	Mounted internally on the fixed hard disk support, or mounted internally in vibration/shock-absorbing hard disk support, or mounted at the front in the low-profile removable drive bay (hot-swap in RAID configurations)

## Memory

Main memory	2 GB to 32 GB DDR3-1600 DIMM, ECC optional
Capacity of main memory, max.	32 Gbyte

## Hardware configuration

Slots	
<ul style="list-style-type: none"> <li>free slots</li> </ul>	11 slots: 7x PCI, 3x PCIe (x4) (1 lane), 1x PCIe (x16) or 3x PCI, 5x PCIe mech. (x16) (4x 4 lanes, 1x 8 lanes), 3x PCIe (x4); all modules to a length of 312 mm can be used

## Interfaces

Interfaces/bus type	1x COM1, 1x COM2 (optional), 1x LPT (optional), 2x DisplayPort, 1x DVI-I, 2x PS/2, audio (Microphone In, Line Out), 7x USB, 2x Gigabit Ethernet, PROFIBUS or PROFINET optional
USB port	2x USB 3.0, 2x USB 2.0 rear, 1x USB 3.0, 1x USB 2.0 front, 1x USB 3.0 internal
Connection for keyboard/mouse	2x PS/2
serial interface	COM1: 1x RS 232, COM2 (optional): 1x RS 232
parallel interface	optional LPT1
Multimedia	
<ul style="list-style-type: none"> <li>Audio In/Out</li> <li>Microphone In</li> </ul>	Yes Yes

## Video interfaces

<ul style="list-style-type: none"> <li>Graphics interface</li> </ul>	2x DisplayPort and 1x DVI-I onboard; 1x VGA via DVI-VGA adapter cable (optional); graphics card PCIe (x16), Dual Head (2x VGA or 2x DVI-D), 1 GB graphics memory (optional)
--	---

## Industrial Ethernet

<ul style="list-style-type: none"> <li>Industrial Ethernet interface</li> <li>— 100 Mbps</li> <li>— 1000 Mbps</li> </ul>	2x Ethernet (RJ45) Yes Yes
--	----------------------------------

## Integrated Functions

Monitoring functions	
<ul style="list-style-type: none"> <li>Temperature monitoring</li> <li>Watchdog</li> <li>Status LEDs</li> <li>Fan</li> <li>Monitoring function via network</li> </ul>	Yes Yes POWER, ETHERNET 1, ETHERNET 2, PN   MPI / DP, WATCHDOG, TEMP, FAN, HDD0 ALARM, HDD1 ALARM, HDD2 ALARM, HDD   HDD3 ALARM Yes Optional

## EMC

Interference immunity against discharge of static electricity	
• Interference immunity against discharge of static electricity	±6 kV contact discharge acc. to IEC 61000-4-2; ±8 kV air discharge acc. to IEC 61000-4-2
Interference immunity against high-frequency electromagnetic fields	
• Interference immunity against high frequency radiation	10 V/m for 80 - 1 000 MHz and 1.4 - 2 GHz, 80% AM acc. to IEC 61000-4-3; 3 V/m for 2 - 2.7 GHz, 80% AM acc. to IEC 61000-4-3; 10 V for 10 kHz - 80 MHz, 80% AM acc. to IEC 61000-4-6
Interference immunity to cable-borne interference	
• Interference immunity on supply cables	±2 kV acc. to IEC 61000-4-4, burst; ±1 kV acc. to IEC 61000-4-5, surge symmetric; ±2 kV acc. to IEC 61000-4-5, surge asymmetric
• Interference immunity on signal cables >30m	±2 kV acc. to IEC 61000-4-4, burst; ±2 kV acc. to IEC 61000-4-5, surge
• Interference immunity on signal cables < 30m	±1 kV acc. to IEC 61000-4-4, Burst
Interference immunity against voltage surge	
• asymmetric interference	±2 kV acc. to IEC 61000-4-5, surge asymmetric
• symmetric interference	±1 kV acc. to IEC 61000-4-5, surge symmetric
Interference immunity to magnetic fields	
• Interference immunity to magnetic fields at 50 Hz	100 A/m; to IEC 61000-4-8
Emission of conducted and non-conducted interference	
• Interference emission via line/AC current cables	EN 61000-6-3, FCC Class A, EN 61000-6-4, CISPR 22, EN 55022 Class B, EN 61000-3-2 Class D, EN 61000-3-3

## Degree and class of protection

IP (at the front)	IP41
IP (rear)	IP20

## Standards, approvals, certificates

CE mark	Yes; For use in industrial areas as well as domestic, business and commercial environments (emitted interference: EN 61000-6-3:2007 +A1:2011, noise immunity: EN 61000-6-2:2005)
CSA approval	Yes; Included in cULus
UL approval	Yes
cULus	Yes; UL 60950-1, file number E115352
RCM (formerly C-TICK)	Yes
KC approval	Yes
EAC (formerly Gost-R)	Yes
EMC	CE, EN 61000-6-3:2007 +A1:2011, EN 61000-6-2:2005
Dust protection	With front door closed: G2 EN 779, 99% of particles > 0.5 mm are filtered

## Ambient conditions

Ambient temperature during operation
--------------------------------------

<ul style="list-style-type: none"> <li>• Ambient temperature during operation</li> </ul>	0 °C to +45 °C, no burner operation, 0 °C to +50 °C, no operation of optical drive, power dissipation of the expansion cards in total < 30 W, maximum 3 removable drive bays, 0 °C to +40 °C with AC UPS, 0 °C to +35 °C with hardware RAID controller
<b>Ambient temperature during storage/transportation</b>	
<ul style="list-style-type: none"> <li>• min.</li> </ul>	-20 °C
<ul style="list-style-type: none"> <li>• max.</li> </ul>	60 °C
<b>Shock testing</b>	
<ul style="list-style-type: none"> <li>• Shock load during operation</li> </ul>	Tested according to IEC 60068-2-27, IEC 60068-2-29: half-sine: 50 m/s <sup>2</sup> (5 g), 30 ms, 100 shocks per axis
<b>Operating systems</b>	
pre-installed operating system	Windows 7 Ultimate, multi-language (32-bit/64-bit), Windows 10 Enterprise 2015 LTSB, multi-language (64-bit), Windows 10 Enterprise 2016 LTSB, multi-language (64-bit), Windows Server 2008 R2 Standard Edition incl. 5 clients, multi-language (64-bit); Windows Server 2012 R2 Standard Edition incl. 5 clients, multi-language (64-bit); Windows Server 2016 Standard Edition incl. 5 clients, multi-language (64-bit)
Additional info on operating system	Multi-Language User Interface (MUI): 5 languages (English, German, French, Spanish, Italian)
without operating system	Yes
<b>Dimensions</b>	
Width	430 mm
Height	177 mm; 4U
Depth	444 mm
<b>last modified:</b>	02/13/2020